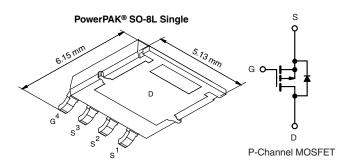


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Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.029				
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5 \text{ V}$	0.047				
I _D (A)	- 40				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- AEC-Q101 Qualified^d
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2011/65/EU



ROHS COMPLIANT HALOGEN FREE

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SQJ443EP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	- 40		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	1	- 40		
Continuous Drain Current	T _C = 125 °C	I _D	- 23		
Continuous Source Current (Diode Conduct	tion) ^a	I _S	- 45	А	
Pulsed Drain Current ^b	I _{DM}	- 158			
Single Pulse Avalanche Current		I _{AS}	- 28		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	39	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	Б	83	w	
	T _C = 125 °C	P_{D}	28		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	۰۵	
Soldering Recommendations (Peak Temperature)e, f			260	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	65	°C/W
Junction-to-Case (Drain)		R_{thJC}	1.8	C/ VV

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.
- e. See Solder Profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0, I _D = - 250 μA	- 40	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 1.5	- 2.0	- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 40 V	-	-	- 1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	ı	-	- 50	μΑ
		$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	ı	-	- 150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	V _{DS} ≤ - 5 V	- 40	-	-	Α
		V _{GS} = - 10 V	I _D = - 18 A	-	0.024	0.029	
Drain-Source On-State Resistance ^a	В	V _{GS} = - 4.5 V	I _D = - 15 A	-	0.038	0.047	Ω
Dialii-Source Oil-State nesistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 18 A; T _J = 125 °C	-	-	0.045	1 22
		V _{GS} = - 10 V	I _D = - 18 A; T _J = 175 °C	-	-	0.055	
Forward Transconductanceb	9 _{fs}	V _{DS} = - 15 V, I _D = - 18 A		-	30	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	1625	2030	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = - 20 V, f = 1 MHz	-	270	355	pF
Reverse Transfer Capacitance	C _{rss}			-	185	240	
Total Gate Charge ^c	Qg			ı	38	57	
Gate-Source Charge ^c	Q_{gs}	V _{GS} = - 10 V	$V_{DS} = -20 \text{ V}, I_{D} = -7.5 \text{ A}$	-	6	-	nC
Gate-Drain Charge ^c	Q_{gd}			-	9	-	
Gate Resistance	R_g		f = 1 MHz	3.15	6.62	10.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	7	11	
Rise Time ^c	t _r	$V_{DD} = 0$	- 20 V, $R_L = 2.67 \Omega$	-	14	21	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -1 A, V$	$V_{\text{GEN}} = -10 \text{ V}, R_{\text{g}} = 6 \Omega$	-	45	67	ns
Fall Time ^c	t _f			-	29	45	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	- 158	Α
Forward Voltage	V_{SD}	l _F :	= - 5 A, V _{GS} = 0	-	- 0.8	- 1.2	V

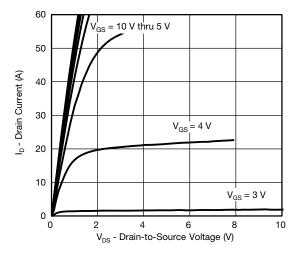
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

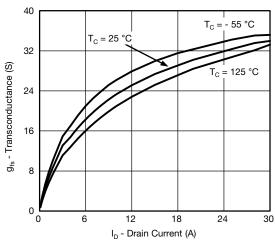
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



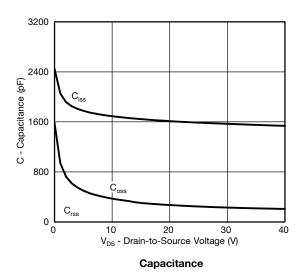
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

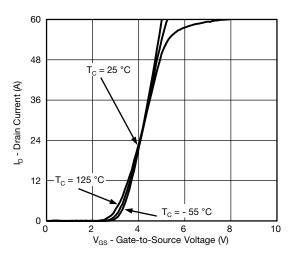


Output Characteristics

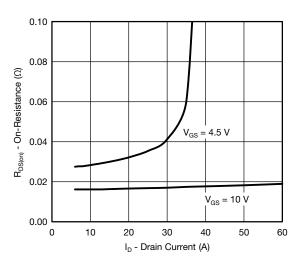


Transconductance

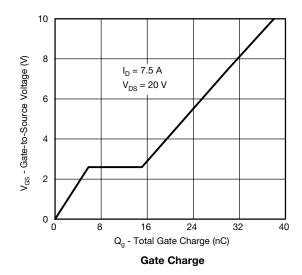




Transfer Characteristics

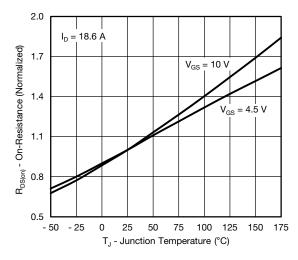


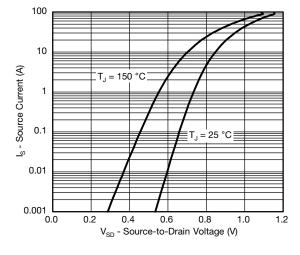
On-Resistance vs. Drain Current



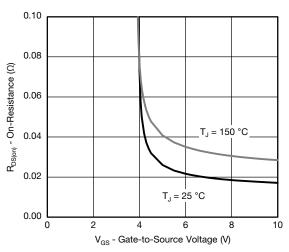


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

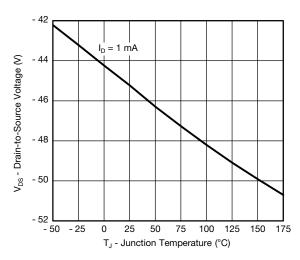




On-Resistance vs. Junction Temperature

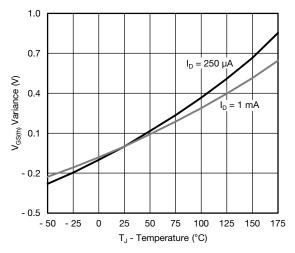


Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

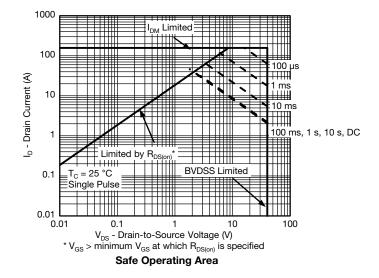
Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_C = 25$ °C, unless otherwise noted)

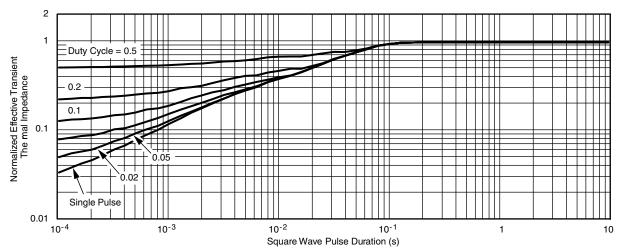


2 1 Duty Cycle = 0.5 Normalized Effective Transient Thermal Impedance 0.1 0.1 0.05 1. Duty Cycle, D = 2. Per Unit Base = R_{thJA} = 65 °C/W 0.02 3. T_{JM} - $T_A = P_{DM}Z_{thJA}(t)$ Single Pulse 4. Surface Mounted 0.01 10-4 10-3 10-2 10⁻¹ 600 Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- · The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg263581.



PowerPAK® SO-8L Case Outline 2



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DIM.		MILLIMETERS		INCHES			
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004	•	
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3	2.96			0.117			
θ	0°	-	10°	0°	-	10°	

ECN: C21-1498-Rev. C, 01-Nov-2021

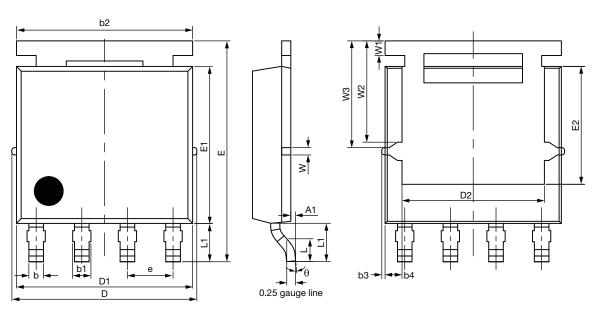
DWG: 6044

Note

• Millimeters will govern

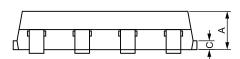


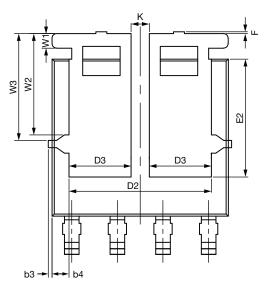
PowerPAK® SO-8L Case Outline 1



Topside view

Backside view (single)





Backside view (dual)



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DIM		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	•		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.133	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51		0.020			
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: S19-0643-Rev. E, 05-Aug-2019

DWG: 5976

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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